



PRODUCT BULLETIN # 16964Generic Copy

Issue Date: 23-Jan-2013**TITLE:** MG2040MUTAG Leadframe Change**PROPOSED FIRST SHIP DATE:** 23-Jan-2013**AFFECTED CHANGE CATEGORY(S):** Assembly**FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:**

Contact your local ON Semiconductor sales office or <SueiHuey.Wong@onsemi.com>

NOTIFICATION TYPE:

ON Semiconductor considers this change approved unless specific conditions of acceptance are provided in writing. To do so, contact <quality@onsemi.com>.

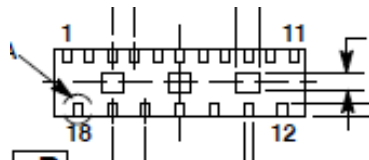
DESCRIPTION AND PURPOSE:

ON Semiconductor is notifying its customers, who purchase MG2040MUTAG of the leadframe change on the pad design.

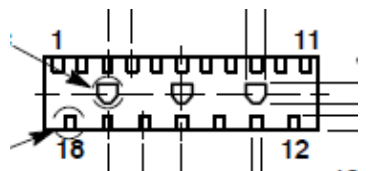
Qualification tests were performed to show that the reliability of the device using the new leadframe will meet or exceed ON Semiconductor standards.

Datasheet will be updated with the new case outline.

Current exposed pad (bottom view):



New exposed pad (bottom view):

**List of affected General Parts:**

MG2040MUTAG